

Nonvolatile, I²C Compatible 64-Position, Digital Potentiometer

Preliminary Technical Data

AD5258

FEATURES

Nonvolatile memoy maintains wiper settings 64-position Compact MSOP-10 (3 mm × 4.9 mm) package I²C° compatible interface V_{LOGIC} pin provides increased interface flexibility. End-to-end resistance 1 kΩ, 10 kΩ, 50 kΩ, 100 kΩ Resistance tolerance stored in EEMEM(0.1% accuracy) Power On EEMEM Refresh Time < 1ms Software write protect command Tri-state address decode pins AD0 and AD1 100-year typical data retention at 55°C Wide operating temperature -40°C to +85°C +3V to +5V single-supply

APPLICATIONS

LCD panel V_{COM} adjustment LCD panel brightness and contrast control Mechanical potentiometer replacement in new designs Programmable power supplies RF amplifier biasing Automotive electronics adjustment Gain control and offset adjustment Low resolution DAC replacement Electronics level settings

GENERAL OVERVIEW

The AD5258 provides a compact nonvolatile 3 mm \times 4.9 mm packaged solution for 64-position adjustment applications. These devices perform the same electronic adjustment function as mechanical potentiometers or variable resistors, with enhanced resolution and solid-state reliability.

The wiper settings are controllable through an I²C compatible digital interface, which can also be used to read back the wiper register and EEMEM content. Resistor tolerance is also stored within EEMEM and can be used to provide an end-to-end tolerance accuracy of 0.1%. In order to provide added security, command bits are available to place the part into a write protect mode in which data can not be written to the EEMEM register.

In addition, a separate V_{LOGIC} pin provides the user with increased interface flexibility. For users who need multiple

Rev. PrH 7/22/04 | Page 1 of 14

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FUNCTIONAL BLOCK DIAGRAMS

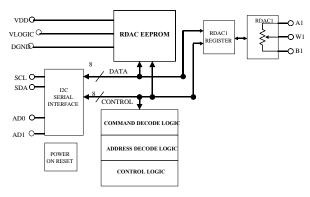


Figure 1.

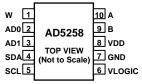


Figure 3. Pinout.

Note:

The terms digital potentiometer, VR, and RDAC are used interchangeably.

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TABLE OF CONTENTS

Electrical Characteristics—1 k Ω , 10 k Ω , 50 k Ω , 100 k Ω
Versions
Timing Characteristics—1 k\Omega, 10 k\Omega, 50 k\Omega, 100 k\Omega Versions 4
Alexandre Marine Dational
Absolute Maximum Ratings ¹ 5
Outline Dimensione
Outline Dimensions

REVISION HISTORY

Revision 0: Initial Version

Ordering Guide 13	3
ESD Caution	3

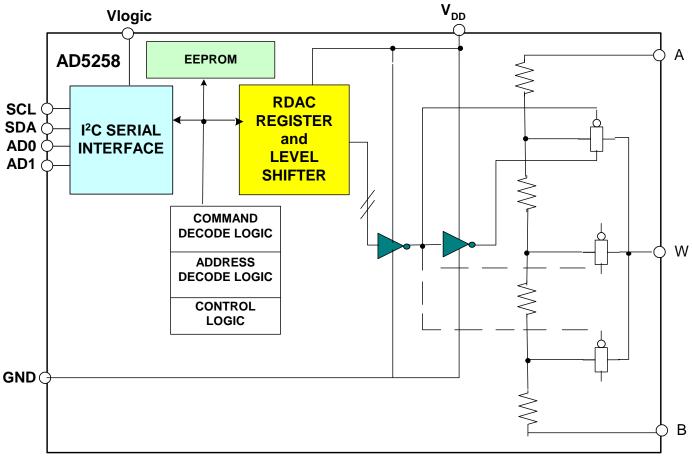


Figure 3. Block diagram showing level shifters

ELECTRICAL CHARACTERISTICS—1 k\Omega, 10 k\Omega, 50 k\Omega, 100 k\Omega VERSIONS

(V_{DD} = 5 V \pm 10%, or 3 V \pm 10%; V_A = V_{DD}; V_B = 0 V; -40°C < T_A < +85°C; unless otherwise noted.)

Table 1.	-			1	1	
Parameter	Symbol	Conditions	Min		Мах	Unit
DC CHARACTERISTICS—RHEOSTAT MODE						
Resistor Differential Nonlinearity	R-DNL	R _{WB} , V _A = no connect	-1	±0.1	+1	LSB
Resistor Integral Nonlinearity	R-INL	R _{WB} , V _A = no connect	-2	±0.25	+2	LSB
Nominal Resistor Tolerance	ΔR_{AB}	$T_A = 25^{\circ}C$	-30		+30	%
Resistance Temperature Coefficient	$\Delta R_{AB} / \Delta T$	V _{AB} = V _{DD} , Wiper = no connect		650		ppm/°C
Rwв	R _{WB}	Code = 0x00		50	120	Ω
DC CHARACTERISTICS—POTENTIOMETER DIVIDE	R MODE					
Differential Nonlinearity	DNL		-1	±0.1	+1	LSB
Integral Nonlinearity	INL		-1	±0.3	+1	LSB
Voltage Divider Temperature Coefficient	ΔV _w /ΔT	Code = 0x20		30		ppm/°C
Full-Scale Error	Vwfse	Code = 0xFF	-3	-1	0	LSB
Zero-Scale Error	V _{WZSE}	Code = 0x00	0	1	3	LSB
RESISTOR TERMINALS						
Voltage Range	V _{A,B,W}		Vss		V _{DD}	V
Capacitance A, B	C _{A,B}	f = 1 MHz, measured to GND, Code = 0x20		45		pF
Capacitance W	Cw	f = 1 MHz, measured to GND, Code = 0x20		60		pF
Common-Mode Leakage	Ісм	$V_A = V_B = V_{DD}/2$		1		nA
DIGITAL INPUTS AND OUTPUTS						
Input Logic High	VIH		$0.7 imes V_L$		V _L +0.5	V
Input Logic Low	VIL		-0.5		$0.3 \times V_{L}$	V
Input Current	l _{IL}	$V_{IN} = 0 V \text{ or } 5 V$			±1	μA
Input Capacitance	CIL			5		pF
POWER SUPPLIES						
Power Supply Range	V _{DD}		2.7		5.5	V
Positive Supply Current	I _{DD}	$V_{IH} = 5 \text{ V or } V_{IL} = 0 \text{ V}$			1	μA
Logic Supply(must match logic levels)	VLOGIC		2.7		V _{DD}	
Programming Mode Current(EEMEM)		$V_{IH} = 5 V \text{ or } V_{IL} = 0 V$		35		mA
Power Dissipation	P _{DISS}	$V_{IH} = 5 V \text{ or } V_{IL} = 0 V,$ $V_{DD} = 5 V$		18	50	μW
Power Supply Sensitivity	PSS	$V_{DD} = +5 V \pm 10\%$, Code = Midscale		±0.02	±0.05	%/%
DYNAMIC CHARACTERISTICS			1			
Bandwidth –3dB	BW	$\begin{aligned} R_{AB} &= 1 k\Omega / 10 k\Omega / 50 k\Omega / 100 \\ k\Omega, Code &= 0 x 20 \end{aligned}$		10000/600/ 100/40		kHz
Total Harmonic Distortion	THDw	$V_A = 1 V rms$, $V_B = 0 V$, f = 1 kHz, $R_{AB} = 10 k\Omega$		0.1		%
V_W Settling Time (1kΩ/10 kΩ/50 kΩ/100 kΩ)	ts	$V_A = 5 V$, $V_B = 0 V$, ±1 LSB error band		2		μs
Resistor Noise Voltage Density	en_wb	$R_{WB} = 5 k\Omega, RS = 0$		9		nV/√Hz

TIMING CHARACTERISTICS—1 kΩ, 10 kΩ, 50 kΩ, 100 kΩ VERSIONS

 $(V_{DD} = +5V \pm 10\%, \text{ or } +3V \pm 10\%; V_A = V_{DD}; V_B = 0 V; -40^{\circ}C < T_A < +85^{\circ}C; \text{ unless otherwise noted.})$

Table 2.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
I ² C INTERFACE TIMING CHARACTERISTICS ¹ (Specifica	tions Apply	to All Parts)				
SCL Clock Frequency	f _{SCL}		0		400	kHz
t_{BUF} Bus Free Time between STOP and START	t 1		1.3			μs
$t_{\text{HD},\text{STA}}$ Hold Time (Repeated START)	t ₂	After this period, the first clock pulse is generated.	0.6			μs
tLOW Low Period of SCL Clock	t ₃		1.3			μs
thigh High Period of SCL Clock	t 4		0.6			μs
tsu;sta Setup Time for Repeated START Condition	t 5		0.6			μs
t _{HD;DAT} Data Hold Time	t ₆		0		0.9	μs
tsu;dat Data Setup Time	t 7		100			ns
t _F Fall Time of Both SDA and SCL Signals	t ₈				300	ns
$t_{\mbox{\tiny R}}$ Rise Time of Both SDA and SCL Signals	t9				300	ns
t _{su;sto} Setup Time for STOP Condition	t ₁₀		0.6			μs

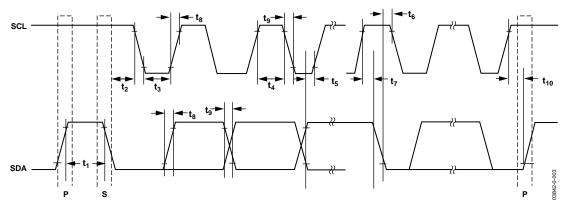


Figure 4. I²C Interface Timing Diagram

I²C INTERFACE

Table 3. Generic Interface Format

	Device Address*																					
S	(7-bit)	R/W	SA	C2	C1	C0	A4	A3	A2	A1	A0	SA	Х	Х	D5	D4	D3	D2	D1	D0	SA	Р
	Slave Address Byte			Instruction Byte											Data	Byte						

Table 4. Device Address Lookup* (Note that AD1 and AD0 are tri-state address pins)

Device Address	AD1	AD0
0011000	0	0
0011001	NC	0
0011010	1	0
0101001	0	NC
0101010	NC	NC
0101011	1	NC
1001100	0	1
1001101	NC	1
1001110	1	1

S = Start Condition P = Stop Condition SA = Slave Acknowledge MA = Master Acknowledge NA = No Acknowledge X = Don't Care \overline{W} = Write R = Read

Table 5. RDAC-to-EEMEM Interface Command Descriptions

C2	C1	C0	Command Description
0	0	0	Operation between I ² C and RDAC
0	0	1	Operation between I ² C and EEPROM
0	1	0	Operation between I ² C and WP register
1	0	0	NOP
1	0	1	Restore EEPROM to RDAC
1	1	0	Store RDAC to EEPROM

Write Modes

Table 6. Writing to RDAC register

Γ		Device Address*																					
	S	(7-bit)	0	SA	0	0	0	0	0	0	0	0	SA	Х	Х	D5	D4	D3	D2	D1	D0	SA	Ρ
		Slave Address Byte			Instruction Byte												Data	Byte					

Table 7. Writing to EEPROM register

		•-																				
	Device Address*																					
S	(7-bit)	0	SA	0	0	1	0	0	0	0	0	SA	Х	Х	D5	D4	D3	D2	D1	D0	SA	Р
	Slave Address Byte			Instruction Byte												Data	Byte					

Table 8. Activating Software Write Protect

c	Device Address*	0	C A		1	0	0	0	0	0	0	C A	0	0	0	0	0	0	0	WD	C A	D
2	(7-bit)	0	SA	0	-	0	0	0	0	0	0	SA	0	0	0	0	0	0	0	WP	SA	Р
	Slave Address Byte			Instruction Byte												Data	Byte					

Store/Restore Modes

Table 9. Storing RDAC value to EEPROM

S	Device Address* (7-bit)	0	SA	1	1	0	0	0	0	0	0	SA	Р
	Slave Address Byte				I	nstr	uct	ion	Byte	;			

Table 10. Restoring EEPROM to RDAC

	Device Address*												
S	(7-bit)	0	SA	1	0	1	0	0	0	0	0	SA	Ρ
	Slave Address Byte				I	nstr	ructi	ion	Byte	<u>;</u>			

S = Start Condition

P = Stop Condition

SA = Slave Acknowledge

MA = Master Acknowledge

NA = No Acknowledge

X = Don't Care

 $\overline{W} = Write$

R = Read

AD5258

Read Modes

Table 11. Traditional Read back of RDAC Register value	
Device Address* S S S Device Address* S Device Address* S S S Device Address* S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S S	
S (7-bit) 0 SA 0 0 0 0 0 0 SA S (7-bit) 1 SA X X D5 D4 D3 D2 I Slave Address Byte Instruction Byte Slave Address Byte Read Back Data	
↓ · · · · · · · · · · · · · · · · · · ·	
Repeat start Table 12. Traditional Read back of stored EEPROM value	
Device Address*	
S (7-bit) 0 SA 0 0 1 0 0 0 0 SA S (7-bit) 1 SA X D5 D4 D3 D2 D3	01 D0 NA P
Slave Address Byte Instruction Byte Slave Address Byte Read Back Data	
\uparrow	
Repeat start	
Table 13. Traditional Read back of Tolerance	
i. Consecutively	
Device Address* Image: Section of the section of t	D1 D0 NA P
Slave Address Slave Address Sign + Integer Byte Decimal Byte Byte Instruction Byte Byte Sign + Integer Byte Decimal Byte	
\uparrow	
Repeat start	
ii. Individually	
Device Address* Address* I I I I I I Device Address* I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I I <thi< th=""> I I</thi<>	
Slave Address Slave Address Sign + Integer Byte Byte Instruction Byte Byte	
\uparrow	
Repeat start	
Device Address* Device Address* <thd< td=""><td></td></thd<>	
Slave AddressSlave AddressDecimal ByteByteInstruction ByteByte	
\uparrow	

Repeat start

Note: Read modes above are referred to as traditional because the first two bytes for all three cases are "dummy" bytes which function to place the pointer towards the correct register. This is the reason for the Repeat Start. In theory, this step can be avoided if the user is interested in reading a register that was previously written to. For example, if the EEPROM was just written to, then the user can skip the

two dummy bytes and proceed directly to the "Slave Address Byte" which would be followed by the "Read Back Data".

Calculating R_{AB} Tolerance Stored in Read-Only Memory

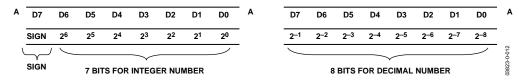


Figure 5. Format of Stored Tolerance in Sign Magnitude Format with Bit Position Descriptions. (Unit is percent. Only data bytes are shown.)

The AD5258 features a patented R_{AB} tolerance storage in the nonvolatile memory. The tolerance is stored in the memory during factory production and can be read by users at any time. The knowledge of stored tolerance allows users to calculate R_{AB} accurately. This feature is valuable for precision, rheostat mode, and open-loop applications where knowledge of absolute resistance is critical.

The stored tolerance resides in the read-only memory, and is expressed as a percentage. The tolerance is stored in two memory locations in sign magnitude binary form(see Figure 5). The two EEMEM address bytes are 11110(sign+integer) and 11111 (decimal number). The two bytes can be accessed individually in two separate commands(see Table 13ii). Alternatively, in order to allow read back of the first byte followed by the second byte in one command(see Table 13i), the memory pointer will automatically increment from the first to the second EEMEM locations(increments from 11110 to 11111) if read consecutively.

In the first memory location, the MSB is designated for the sign (0 = + and 1 = -) and the 7 LSBs are designated for the integer portion of the tolerance. In the second memory location, all eight data bits are designated for the decimal portion of tolerance. For example, if the rated $R_{AB} = 10 \text{ k}\Omega$ and the data readback from Address 11110 shows 0001 1100 and Address 11111 shows 0000 1111, then the tolerance can be calculated as

$$\begin{split} MSB: 0 &= + \\ Next 7 \ MSB: 001 \ 1100 &= 28 \\ 8 \ LSB: 0000 \ 1111 &= 15 \times 2^{-8} &= 0.06 \\ Tolerance &= +28.06\% \ and \ therefore \\ R_{AB_ACTUAL} &= 12.806 \ k\Omega \end{split}$$

EEMEM Write-Acknowledge Polling

After each write operation to the EEMEM registers, an internal write cycle begins. The I²C interface of the device is disabled. To determine if the internal write cycle is complete and the I²C interface is enabled, interface polling can be executed. I²C interface polling can be conducted by sending a start condition followed by the slave address + the write bit. If the I²C interface responds with an ACK, the write cycle is complete and the interface is ready to proceed with further operations. Other-wise, I²C interface polling can be repeated until it succeeds.

I²C COMPATIBLE 2-WIRE SERIAL BUS

1. The master initiates data transfer by establishing a START condition, which is when a high-to-low transition on the SDA line occurs while SCL is high (see Figure 4). The following byte is the Slave Address Byte, which consists of the slave address followed by an R/\overline{W} bit (this bit determines whether data is read from or written to the slave device).

The AD5258 has two tri-state configurable address bits, AD0 and AD1 (see Table 4). The slave whose address corresponds to the transmitted address responds by pulling the SDA line low during the ninth clock pulse (this is termed the acknowledge bit). At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to or read from its serial register. If the R/W bit is high, the master reads from the slave device. If the R/W bit is low, the master writes to the slave device.

 Writing: In the write mode, the last bit(R/W) of the Address Byte is logic low. The second byte is the Instruction Byte. The first 3 bits of the Instruction Byte are the command bits(see Table 5). The final 5 bits indicate which EEMEM location the pointer moves to. The user must choose whether to write to the RDAC register, EEMEM register, or activate the software write protect(see Tables 6-8).

The final byte is the Data Byte MSB first. In the case of the write protect mode, data is not being stored. Rather, a logic high in the LSB will enable write protect and a logic low will disable write protect.

Storing/Restoring: In this mode, only two bytes are necessary; Address and Instruction Bytes. The last bit (R/W) of the Address Byte is logic low. The first 3 bits of the Instruction Byte are the command bits(see Table 5). The two choices are transfer data from RDAC to EEMEM(Store) or from EEMEM to RDAC(Restore). The final 5 bits are all zeros(see Tables 9-10).

- 4. **Reading:** Assuming the register of interest was not just written to, it is necessary to write a dummy Address and Instruction Byte. The Instruction Byte will vary depending on whether the data that is wanted is the RDAC register, EEMEM register, or Tolerance register(see Tables 11-13). The Tolerance register can be read back consecutively(Table 13i) or individually(Table13ii). Refer to page 8 for detailed information on the interpretation of the tolerance bytes. After the dummy Address and Instruction Bytes are sent, a repeat start is necessary. After the repeat start, another Address Byte is needed except this time, the R/\overline{W} bit is logic **high**. Following this Address Byte is the Read Back Byte containing the information requested in the Instruction Byte.
- 5. After all data bits have been read or written, a STOP condition is established by the master. A STOP condition is defined as a low-to-high transition on the SDA line while SCL is high. In write mode, the master pulls the SDA line high during the 10th clock pulse to establish a STOP condition (see Figure 6). In read mode, the master issues a No Acknowledge for the ninth clock pulse (i.e., the SDA line remains high). The master then brings the SDA line low before the 10th clock pulse, and then raises SDA high to establish a STOP condition (see Figure 7).

A repeated write function gives the user flexibility to update the RDAC output a number of times after addressing and instructing the part only once. For example, after the RDAC has acknowledged its Slave Address and Instruction Bytes in the write mode, the RDAC output is updated on each successive byte. If different instructions are needed, the write/read mode has to start again with a new Slave Address, Instruction, and Data Byte. Similarly, a repeated read function of the RDAC is also allowed.

DISPLAY APPLICATIONS

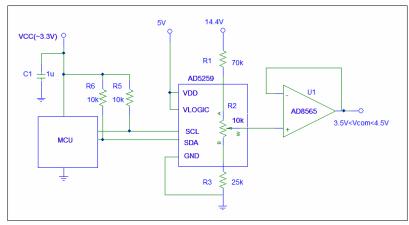


Figure 1. V_{COM} adjustment application assuming that a +5V supply is available. In this case, V_{DD} and V_{LOGIC} would be tied together.

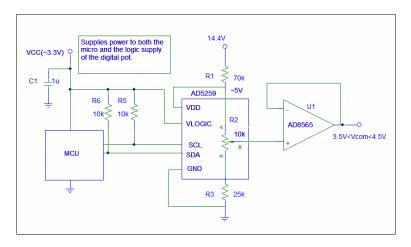


Figure 2. This circuit demonstrates the flexibility of a V_{LOGIC} pin when a separate supply is not available for V_{DD} . V_{DD} can be tapped off the +14.4V where it is resistor divided down to approximately ~5V. V_{LOGIC} can then be taken off the same supply that powers the MCU's logic levels. Now, the 35 mA programming current will be drawn by V_{LOGIC} , and V_{DD} will only draw microamps of supply current used to bias up the internal switches in the digital potentiometer's internal resistor string.

ABSOLUTE MAXIMUM RATINGS¹

($T_A = +25^{\circ}$ C, unless otherwise noted.)

Table 4

Parameter	Value	
V _{DD} to GND	–0.3 V to +7 V	
V _A , V _B , V _W to GND	Vss -0.3V, VDD+0.3V	
Імах		
Pulsed ¹	±20 mA	
Continuous	±5 mA	
Digital Inputs and Output Voltage to GND	0 V to +7 V	
Operating Temperature Range	-40°C to +85°C	
Maximum Junction Temperature (T _{JMAX})	150°C	
Storage Temperature	–65°C to +150°C	
Lead Temperature (Soldering, 10 sec)	300°C	
Thermal Resistance ² θ _{JA} : MSOP-10	200°C/W	

NOTES

¹ Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the A, B, and W terminals at a given resistance.

² Package power dissipation = $(T_{JMAX} - T_A)/\theta_{JA}$.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

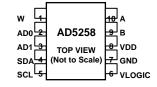


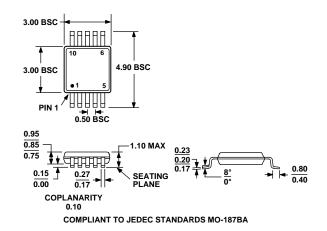
Figure 2. AD5172 Pin Configuration

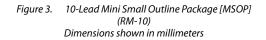
Table 5. AD5258 Pin Function Descriptions

Pin	Mnemonic	Description	
1	W	W Terminal. $GND \le V_W \le V_{DD}$.	
2	ADO	Programmable Tri-State Address Bit 0 for Multiple Package Decoding.	
3	AD1	Programmable Tri-State Address Bit 1 for Multiple Package Decoding.	
4	SDA	Serial Data Input/Output.	
5	SCL	Serial Clock Input. Positive edge triggered.	
6	VLOGIC	Logic power supply.	
7	GND	Digital Ground.	
8	VDD	Positive Power Supply.	
9	В	B Terminal. GND $\leq V_{B} \leq V_{DD}$.	
10	А	A Terminal. $GND \le V_A \le V_{DD}$.	

AD5258

Outline Dimensions





ORDERING GUIDE

Model	R _{AB} (Ω)	Temperature	Package Description	Package Option	Branding
AD5258BRMZ11	1k	-40°C to +85°C	MSOP-10	RM-10	D4K
AD5258BRMZ1-RL71	1k	-40°C to +85°C	MSOP-10	RM-10	D4K
AD5258BRMZ101	10k	-40°C to +85°C	MSOP-10	RM-10	D4L
AD5258BRMZ10-RL71	10k	-40°C to +85°C	MSOP-10	RM-10	D4L
AD5258BRMZ501	50k	-40°C to +85°C	MSOP-10	RM-10	D4M
AD5258BRMZ50-RL71	50k	-40°C to +85°C	MSOP-10	RM-10	D4M
AD5258BRMZ1001	100k	-40°C to +85°C	MSOP-10	RM-10	D4N
AD5258BRMZ100-RL71	100k	-40°C to +85°C	MSOP-10	RM-10	D4N

 1 Z = Pb-free part.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



AD5258

NOTES



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